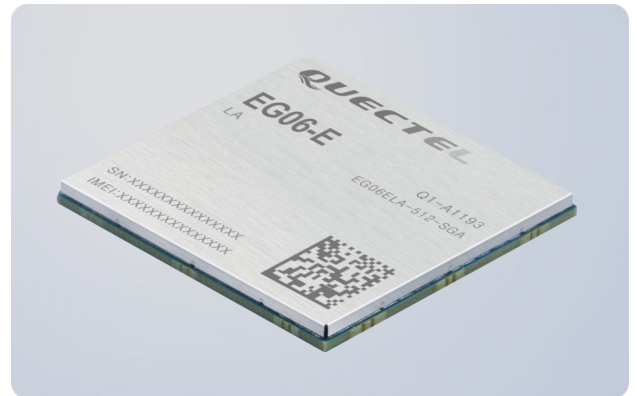


Quectel EG06

IoT/M2M-optimized LTE-A Cat 6 LGA Module



Quectel EG06 is a series of LTE Advanced category 6 module optimized specially for M2M and IoT applications. Adopting the 3GPP Rel. 11 LTE technology, it delivers M2M-optimized speeds of 300Mbps downlink and 50Mbps uplink peak data rates.

Designed in the LGA form factor, EG06 contains 5 variants (EG06-E, EG06-A, EG06-AUTL, EG06-LA^① and EG06-EL^①) for different target regions and these variants nearly cover all the main stream carriers worldwide.

EG06 supports Qualcomm® IZat™ location technology Gen8C Lite (GPS, GLONASS, BeiDou, Galileo and QZSS). The integrated GNSS greatly simplifies product design, and provides quicker, more accurate and more dependable positioning capability.

A rich set of Internet protocols, industry-standard interfaces and abundant functionalities (USB drivers for Windows 7, Windows 8/8.1, Windows 10, Linux, Android) extend the applicability of the module to a wide range of M2M and IoT applications such as industrial router, home gateway, set top box, industrial PDA, rugged tablet PC, video surveillance and digital signage, etc.



Key Benefits

- ✓ LTE-A Cat 6 module with LGA form factor, optimized for M2M and IoT applications
- ✓ Supports LTE-A carrier aggregation
- ✓ Worldwide LTE-A and UMTS/HSPA+ coverage
- ✓ Multi-constellation GNSS receiver available for applications requiring fast and accurate fixes in any environment
- ✓ Feature refinements: supports DFOTA and DTMF
- ✓ MIMO technology meets demands for data rate and link reliability in modem wireless communication systems



LTE Cat 6
Max 300Mbps (DL)
Max 50Mbps (UL)



Max 42Mbps (DL)
Max 5.76Mbps (UL)



LGA Package



Embedded Abundant
Protocols



Voice over LTE



Multi-constellation
GNSS



USB 2.0/3.0 Interface



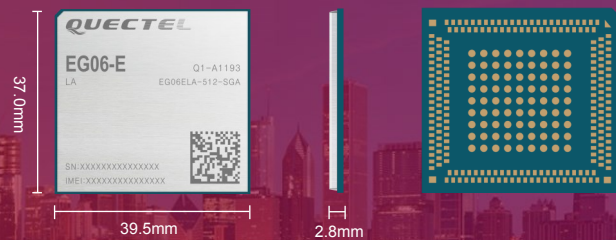
USB Drivers



Quectel Enhanced
AT Commands

Quectel EG06

IoT/M2M-optimized LTE-A Cat 6 LGA Module



Variant for EMEA/APAC^②/Brazil

EG06-E

LTE-FDD: B1/B3/B5/B7/B8/B20/B28/B32^③

LTE-TDD: B38/B40/B41

2×CA: B1+B1/B5/B8/B20/B28;

B3+B3/B5/B7/B8/B20/B28;

B7+B5/B7/B8/B20/B28;

B20+B32^③; B38+B38; B40+B40; B41+B41

WCDMA: B1/B3/B5/B8

Variant for North America

EG06-A

LTE-FDD: B2/B4/B5/B7/B12/B13/B25/B26/
B29^③/B30/B66

2×CA: B2+B2/B5/B12/B13/B29^③;

B4+B4/B5/B12/B13/B29^③;

B7+B5/B7/B12/B26;

B25+B5/B12/B25/B26;

B30+B5/B12/B29^③;

B66+B5/B12/B13/B29^③/B66

WCDMA: B2/B4/B5

Variant for Australia

EG06-AUTL^④

LTE-FDD: B3/B7/B28

2×CA: B3+B3/B7/B28; B7+B7/B28

Variant for Latin America

EG06-LA (Under Planning)

LTE-FDD: B2/B3/B4/B5/B7/B8/B20/B28

2×CA: B2+B2/B5/B8/B20/B28;

B3+B3/B5/B7/B8/B20/B28;

B4+B4/B5/B8/B20/B28;

B7+B5/B7/B8/B20/B28

WCDMA: B2/B3/B4/B5/B8

Variant for EMEA/APAC^⑤/Brazil

EG06-EL (Under Planning)

LTE-FDD: B1/B3/B5/B7/B8/B20/B28

LTE-TDD: B38/B39/B40/B41

2×CA: B1+B1/B3/B5/B7/B8/B20/B28;

B3+B3/B5/B7/B8/B20/B28;

B7+B5/B7/B8/B20/B28;

B38+B38; B39+B41;

B40+B40; B41+B41

Data

LTE:

LTE-FDD: Max 300Mbps (DL)^④/Max 50Mbps (UL)

LTE-TDD: Max 226Mbps (DL)/Max 28Mbps (UL)

UMTS:

DC-HSDPA: Max 42Mbps

HSUPA: Max 5.76Mbps

WCDMA: Max 384Kbps (DL)/Max 384Kbps (UL)

SMS

Point-to-point MO and MT

SMS Cell Broadcast

Text and PDU Mode

Interfaces

USB 2.0/3.0 × 1: Support Master* and Slave Modes

PCM × 1: Digital Audio

(U)SIM × 1: 1.8V/3.0V

GPIO × 2

UART × 3

PCIe(RC)* × 1: PCIe Gen 2, for Wi-Fi, Ethernet Functions

SD Card Interface* × 1

ADC × 2

I2C × 1

RESET_N: Reset the Module

Main, Diversity and GNSS Antenna Interfaces

Enhanced Features

MIMO: 2 × 2, 4 × 2, DL

Digital Audio and VoLTE (Voice over LTE) (Optional)

(U)SIM Card Detection

DTMF: Dual-tone Multi-frequency

DFOTA: Delta Firmware Upgrade Over-the-Air

Ethernet*/Wi-Fi* Function through PCIe

Interface

GNSS: GPS/GLONASS/BeiDou/Galileo/QZSS

Electrical Characteristics

Output Power:

Class 3 (23dBm±2dB) for LTE-FDD

Class 3 (23dBm±2dB) for LTE-TDD

Class 3 (24dBm+1/-3dB) for WCDMA

Consumption:

10uA @Power off

1.5mA@Sleep (PF=128)

2.1mA@Sleep (PF=64)

18mA @Idle

Software Features

MBIM Driver:

Windows 10

USB Serial Driver:

Windows 7/8/8.1/10,

WinCE 5.0/6.0/7.0*, Linux 2.6/3.x/4.1~4.14,

Android 4.x/5.x/6.x/7.x/8.x

RIL Driver:

Android 4.x/5.x/6.x/7.x/8.x

NDIS Driver:

Windows 7/8/8.1/10

ECM Driver*:

Linux 2.6/3.x/4.1~4.14

Gobinet Driver:

Linux 2.6/3.x/4.1~4.14

QMI_WWAN Driver:

Linux 3.x (3.4 or later)/4.1~4.14

Protocols:

PPP/QMI/TCP*/UDP*/FTP*/HTTP*/NTP*/PING*/

HTTPS*/SMTP*/MMS*/FTPS*/SMTPS*/SSL*

General Features

3GPP E-UTRA Release 11

Bandwidth: 1.4/3/5/10/15/20/40 (2×CA)MHz

Supply Voltage: 3.3V~4.3V, 3.8V Typ.

Temperature Range: -40°C ~ +85°C

Dimensions: 37.0mm × 39.5mm × 2.8mm

LGA Package

Approx. 6.7g

3GPP TS27.007 and Quectel Enhanced AT

Commands

Approvals

GCF (Global)

CE/Deutsche Telekom* (Europe)

RCM/Telstra (Australia)

FCC/PTCRB/IC/AT&T*/Verizon* (North America)

CCC* (China)

KC/KT* (Korea)

① Under Planning.

② Excluding Japan and CMCC.

③ LTE-FDD B29 and B32 Support Rx Only, and in 2×CA They are Only for Secondary Component Carrier.

④ EG06-AUTL Supports 400Mbps DL Peak Data Rates with 256-QAM Modulation.

⑤ Excluding Japan.

* Under Development.